

Application No. 10/625,512
Amendment under 37 CFR 1.312

REMARKS

Claims 19, 20, 22, 24, 26, 27, 29, 30, 32 and 35 to 40 are active in the case.

The present invention relates to a process of producing a resin encapsulated semiconductor device.

Claim Amendments

Claim 24 has been amended in order to correct a minor spelling error therein. The correction does not introduce new matter into the case. Entry of the amendment is respectfully requested.

It is submitted that this application is in proper condition for issue.

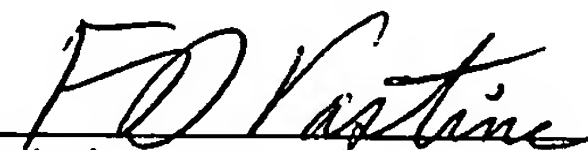
Respectfully submitted,

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